



**THE DATASHEET OF
PMEG3001EEFZ**





PMEG3001EEF

30 V, 0.1 A low VF MEGA Schottky barrier rectifier

17 September 2019

Product data sheet

1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection in a DFN0603-2 (SOD972E) leadless ultra small Surface-Mounted Device (SMD) package.

2. Features and benefits

- Average forward current $I_{F(AV)} \leq 0.1$ A
- Reverse voltage $V_R \leq 30$ V
- Low forward voltage
- Low leakage current
- Ultra small and leadless SMD package
- Package height typ. 0.25 mm

3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Low power consumption applications
- Ultra high speed switching
- LED backlight for mobile application

4. Quick reference data

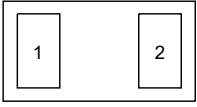

Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------|-------------------------|--|-----|------|-----|---------|
| $I_{F(AV)}$ | average forward current | $\delta = 0.5$; $f = 20$ kHz; $T_{sp} \leq 147$ °C; square wave | - | - | 0.1 | A |
| V_R | reverse voltage | $T_j = 25$ °C | - | - | 30 | V |
| V_F | forward voltage | $I_F = 10$ mA; $T_j = 25$ °C; pulsed | - | 415 | 460 | mV |
| I_R | reverse current | $V_R = 10$ V; $T_j = 25$ °C; pulsed | [1] | 0.02 | 0.1 | μ A |
| | | $V_R = 30$ V; $T_j = 25$ °C; pulsed | [1] | 0.14 | 0.5 | μ A |

[1] Very short pulse, to maintain a stable junction temperature.

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------|---|---|
| 1 | K | cathode |  <p>Transparent top view DFN0603-2 (SOD972E)</p> |  sym001 |
| 2 | A | anode | | |

6. Ordering information

Table 3. Ordering information

| Type number | Package | | |
|-------------|-----------|--|---------|
| | Name | Description | Version |
| PMEG3001EEF | DFN0603-2 | plastic, ultra small and leadless full encapsulated package; 2 terminals; 0.4 mm pitch; 0.63 mm x 0.33 mm x 0.25 mm body | SOD972E |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PMEG3001EEF | J |

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|-------------|-------------------------------------|---|-----|-----|------|------|
| V_R | reverse voltage | $T_j = 25\text{ °C}$ | | - | 30 | V |
| I_F | forward current | $\delta = 1$; $T_{sp} \leq 146\text{ °C}$; $f = 20\text{ kHz}$; square wave | | - | 0.14 | A |
| $I_{F(AV)}$ | average forward current | $\delta = 0.5$; $f = 20\text{ kHz}$; $T_{amb} \leq 131\text{ °C}$; square wave | | - | 0.1 | A |
| | | $\delta = 0.5$; $f = 20\text{ kHz}$; $T_{sp} \leq 147\text{ °C}$; square wave | | - | 0.1 | A |
| I_{FRM} | repetitive peak forward current | $t_p \leq 1\text{ ms}$; $\delta \leq 0.25$ | | - | 1 | A |
| I_{FSM} | non-repetitive peak forward current | $t_p = 8.3\text{ ms}$; square wave; $T_{j(init)} = 25\text{ °C}$ | | - | 3 | A |
| P_{tot} | total power dissipation | $T_{amb} \leq 25\text{ °C}$ | [1] | - | 370 | mW |
| | | | [2] | - | 570 | mW |
| T_j | junction temperature | | | - | 150 | °C |
| T_{amb} | ambient temperature | | | -55 | 150 | °C |
| T_{stg} | storage temperature | | | -55 | 150 | °C |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for anode and cathode 1 cm^2 each.

9. Thermal characteristics

Table 6. Thermal characteristics

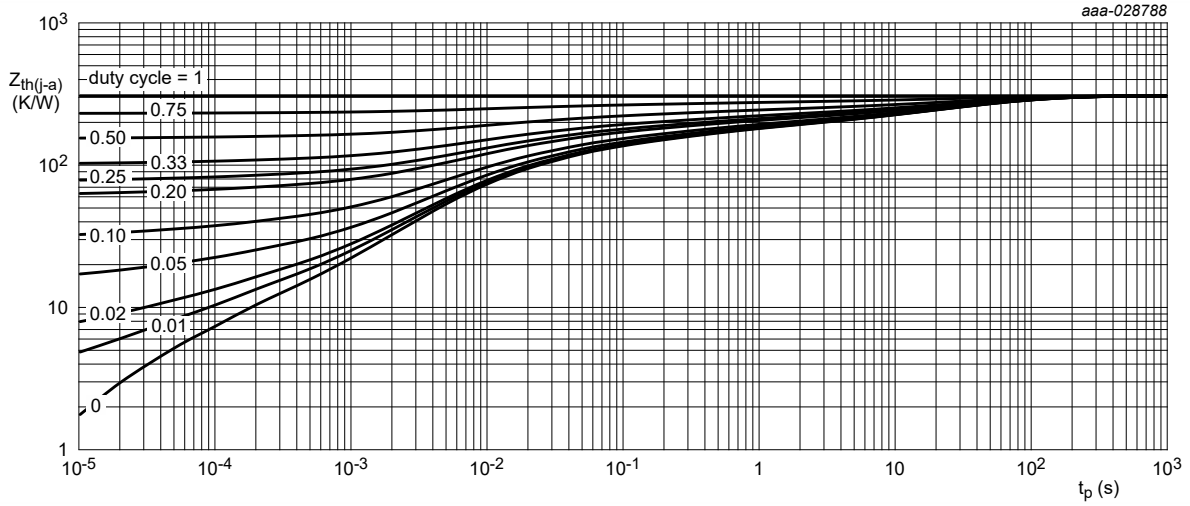
| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|----------------|--|-------------|---------|-----|-----|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | [1] [2] | - | - | 340 | K/W |
| | | | [1] [3] | - | - | 220 | K/W |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point | | [4] | - | - | 35 | K/W |

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

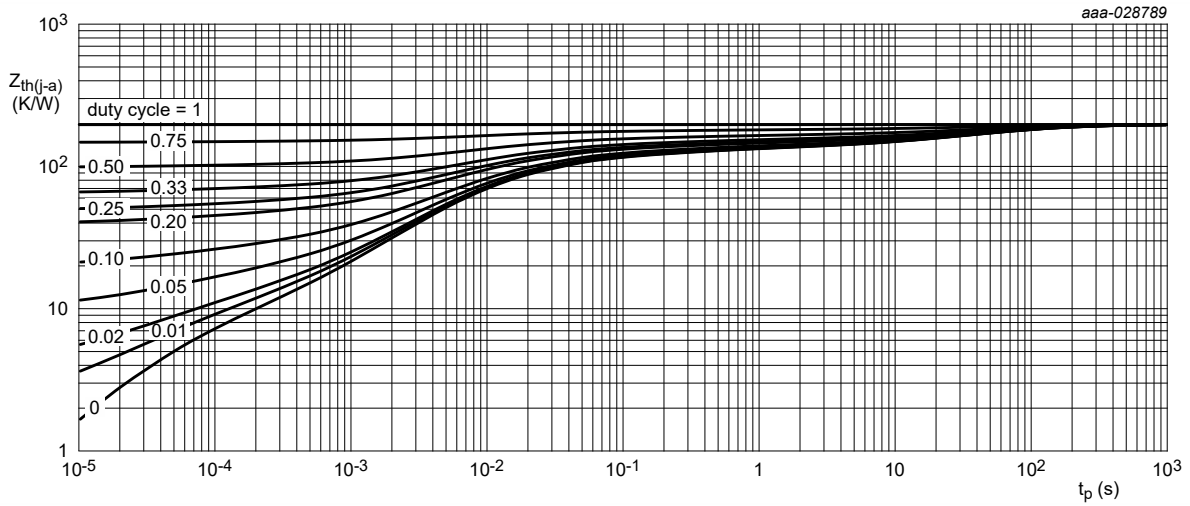
[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for anode and cathode 1 cm^2 each.

[4] Soldering point of anode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for anode and cathode 1 cm² each

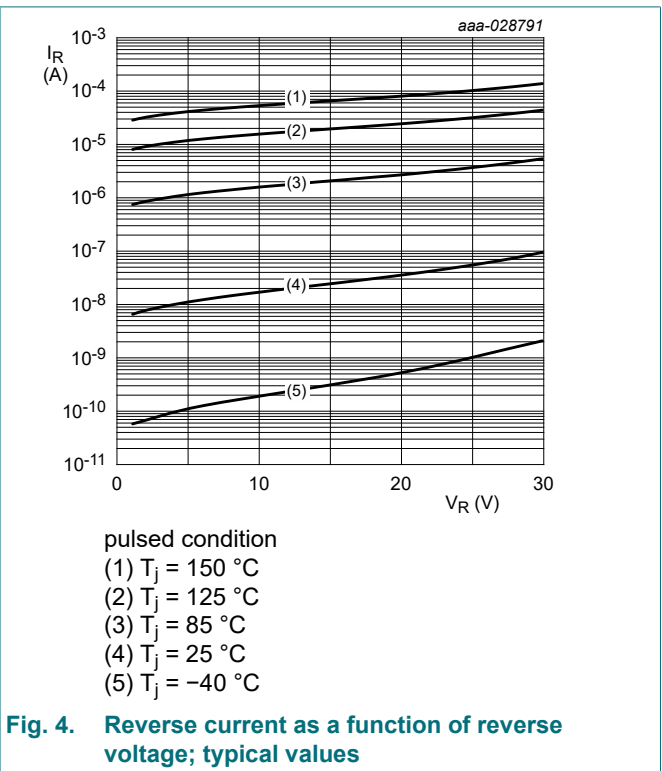
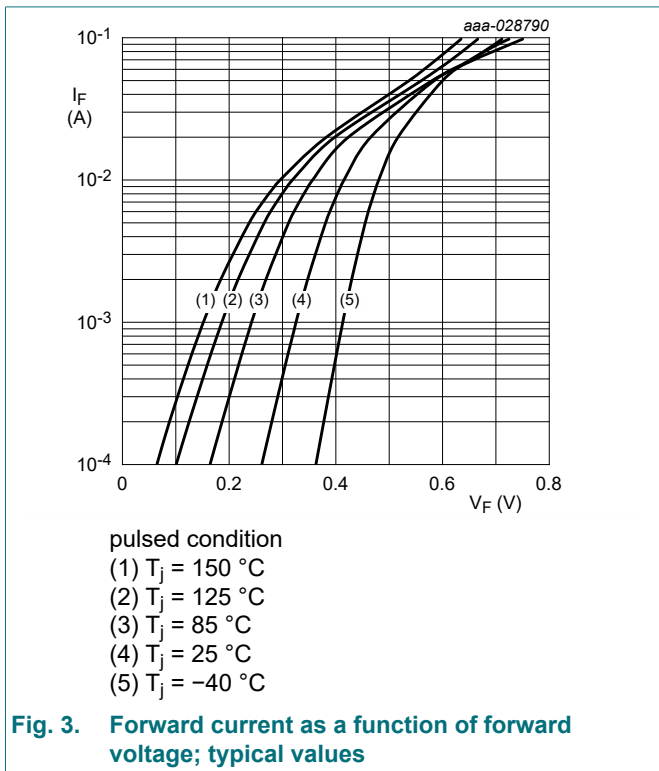
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

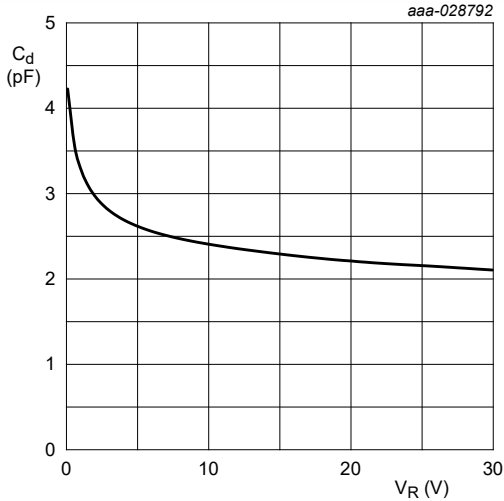
10. Characteristics

Table 7. Characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------|---------------------------------------|--|-----|------|-----|---------------|
| $V_{(BR)R}$ | reverse reverse breakdown voltage | $I_R = 0.1 \text{ mA}$; pulsed; $T_j = 25 \text{ }^\circ\text{C}$ | [1] | 30 | - | V |
| V_F | forward voltage | $I_F = 0.1 \text{ mA}$; $T_j = 25 \text{ }^\circ\text{C}$; pulsed | - | 260 | - | mV |
| | | $I_F = 1 \text{ mA}$; $T_j = 25 \text{ }^\circ\text{C}$; pulsed | - | 325 | 360 | mV |
| | | $I_F = 10 \text{ mA}$; $T_j = 25 \text{ }^\circ\text{C}$; pulsed | - | 415 | 460 | mV |
| | | $I_F = 100 \text{ mA}$; $T_j = 25 \text{ }^\circ\text{C}$; pulsed | - | 725 | 840 | mV |
| I_R | reverse current | $V_R = 10 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$; pulsed | [1] | 0.02 | 0.1 | μA |
| | | $V_R = 30 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$; pulsed | [1] | 0.14 | 0.5 | μA |
| C_d | diode capacitance | $V_R = 1 \text{ V}$; $f = 1 \text{ MHz}$; $T_j = 25 \text{ }^\circ\text{C}$ | - | 4 | - | pF |
| | | $V_R = 10 \text{ V}$; $f = 1 \text{ MHz}$; $T_j = 25 \text{ }^\circ\text{C}$ | - | 3 | - | pF |
| t_{rr} | reverse recovery time ; step recovery | $I_F = 100 \text{ mA}$; $I_R = 100 \text{ mA}$; $I_{R(\text{meas})} = 20 \text{ mA}$; $T_j = 25 \text{ }^\circ\text{C}$ | - | 1.5 | - | ns |

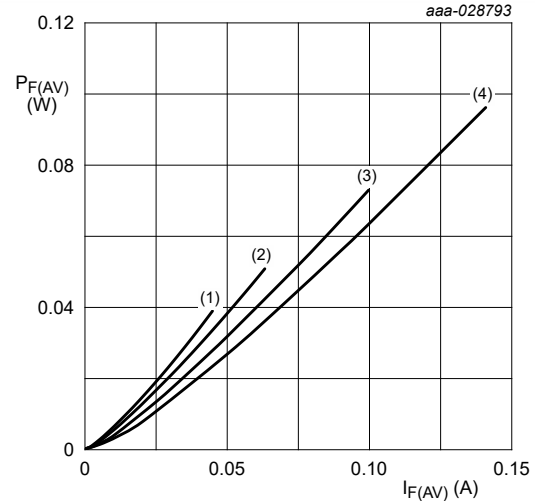
[1] Very short pulse, to maintain a stable junction temperature.





$f = 1 \text{ MHz}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$

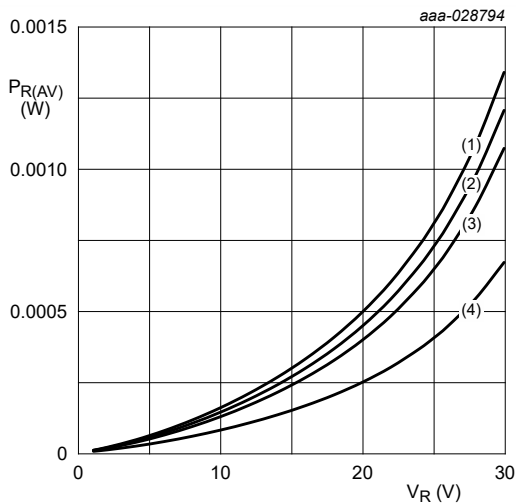
Fig. 5. Diode capacitance as a function of reverse voltage; typical values



$T_j = 150 \text{ }^\circ\text{C}$

- (1) $\delta = 0.1$
- (2) $\delta = 0.2$
- (3) $\delta = 0.5$
- (4) $\delta = 1$

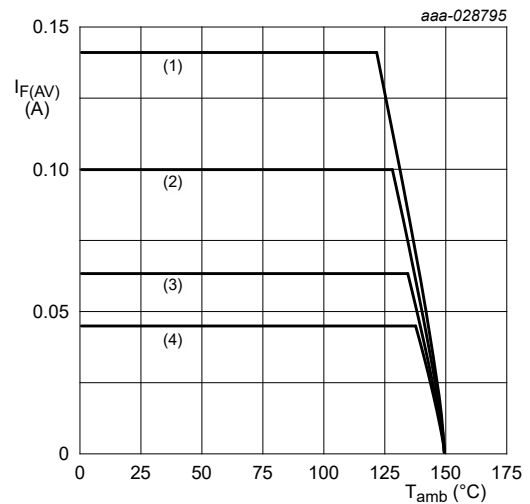
Fig. 6. Average forward power dissipation as a function of average forward current; typical values



$T_j = 125 \text{ }^\circ\text{C}$

- (1) $\delta = 1$
- (2) $\delta = 0.9$
- (3) $\delta = 0.8$
- (4) $\delta = 0.5$

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values

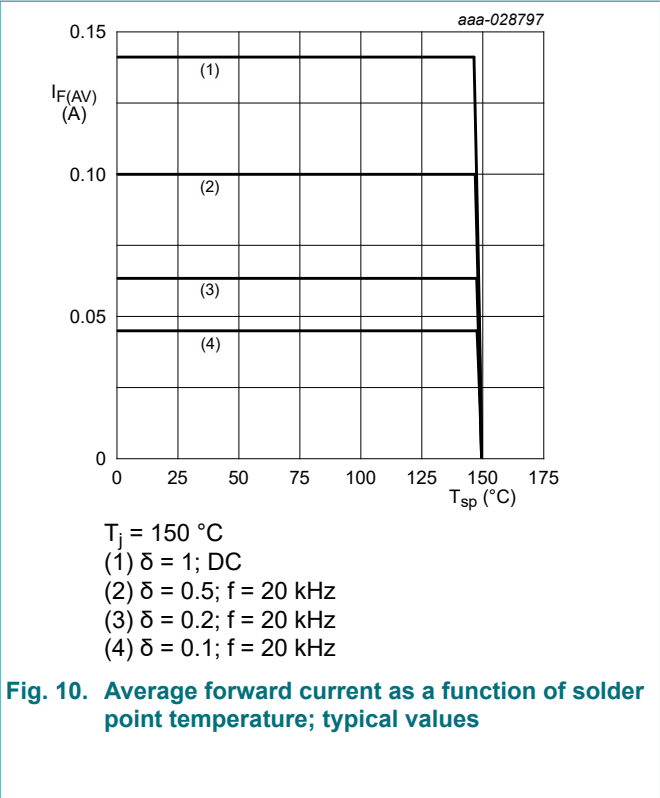
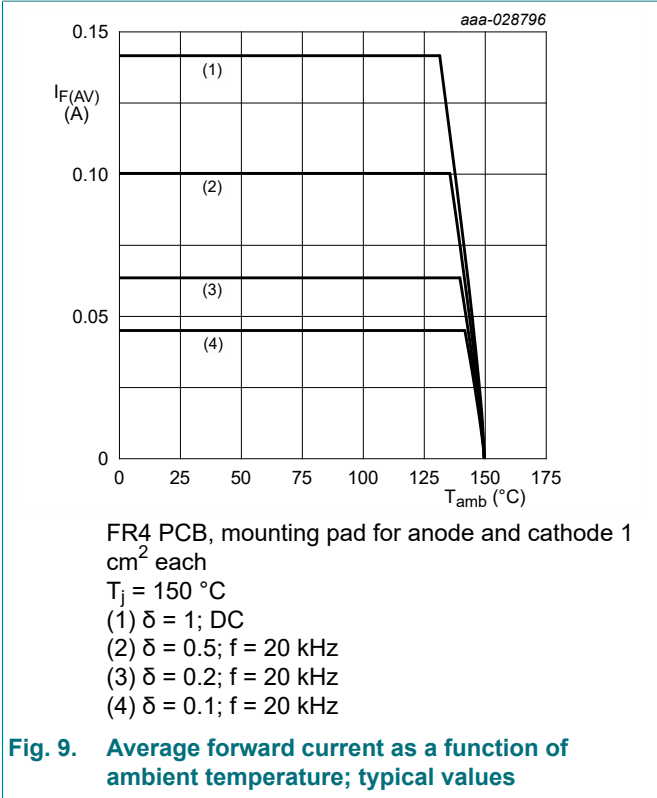


FR4 PCB, standard footprint

$T_j = 150 \text{ }^\circ\text{C}$

- (1) $\delta = 1; \text{DC}$
- (2) $\delta = 0.5; f = 20 \text{ kHz}$
- (3) $\delta = 0.2; f = 20 \text{ kHz}$
- (4) $\delta = 0.1; f = 20 \text{ kHz}$

Fig. 8. Average forward current as a function of ambient temperature; typical values



11. Test information

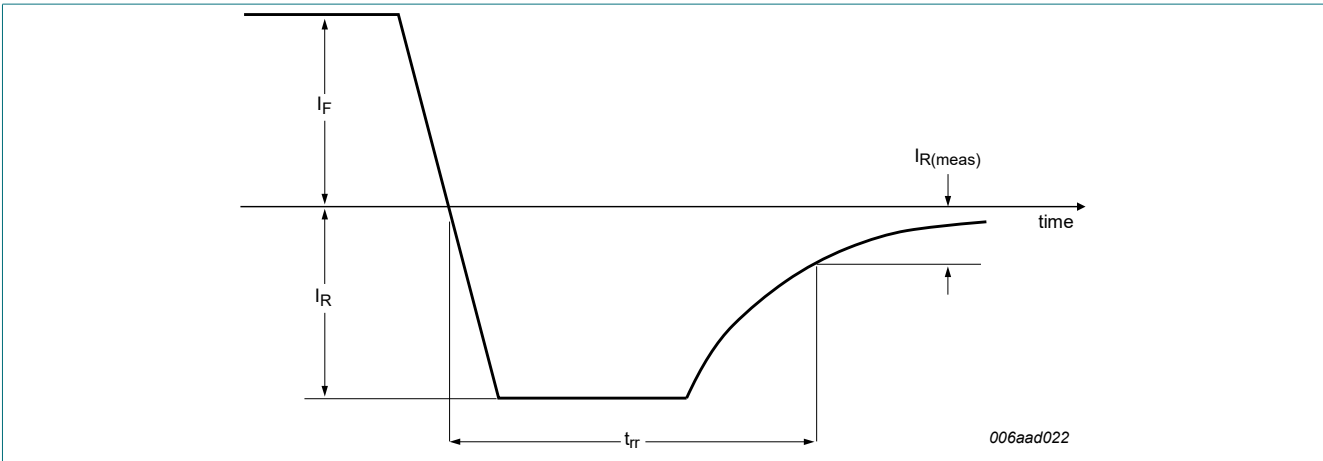


Fig. 11. Reverse recovery definition

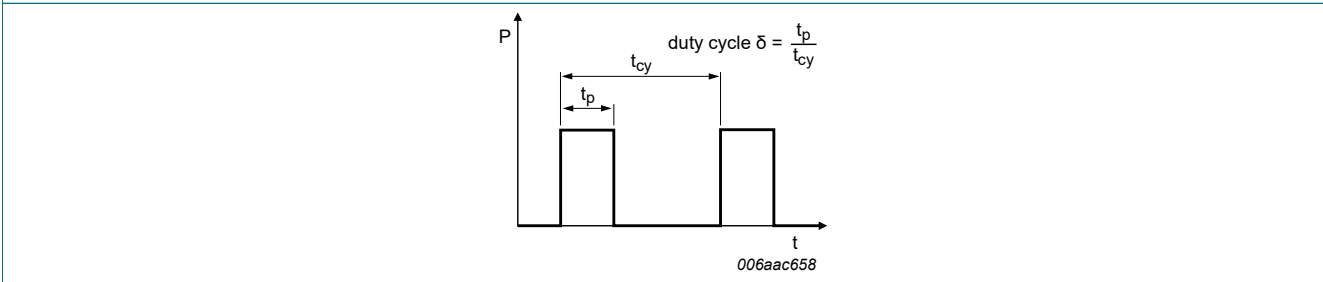


Fig. 12. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

12. Package outline

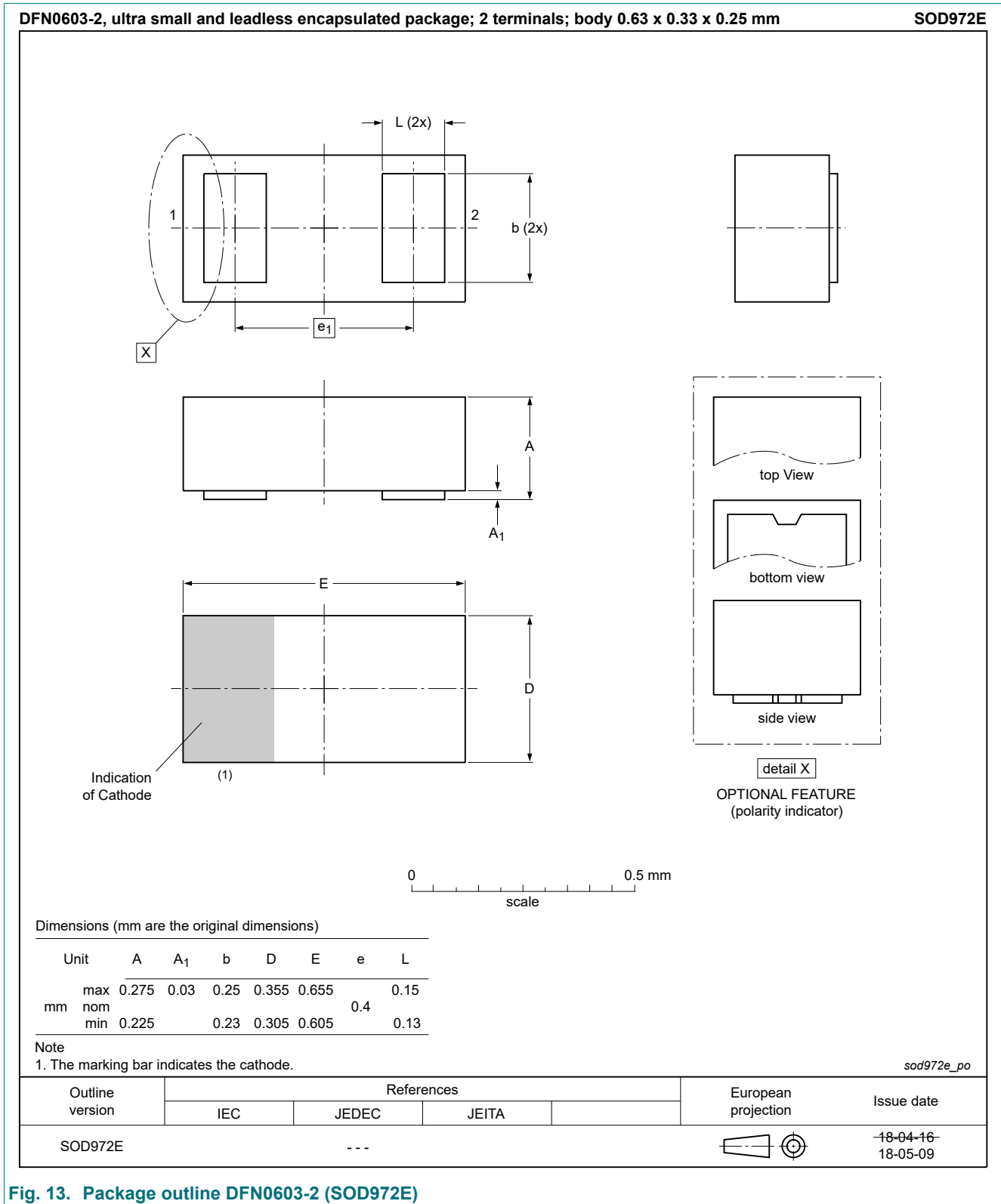
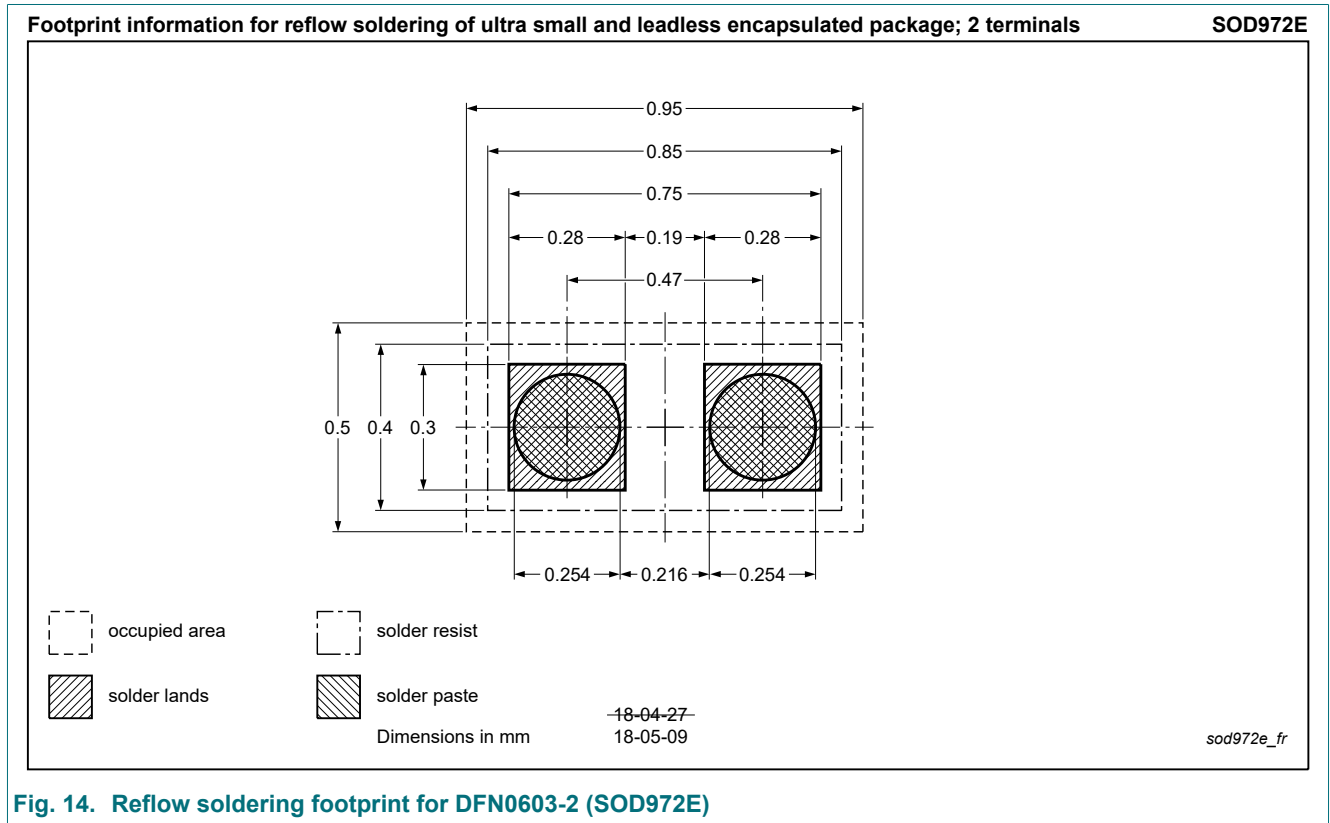


Fig. 13. Package outline DFN0603-2 (SOD972E)

13. Soldering



14. Revision history

Table 8. Revision history

| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes |
|-----------------|--|----------------------|---------------|-----------------|
| PMEG3001EEF v.5 | 20190917 | Product data sheet | - | PMEG3001EEF v.4 |
| Modifications: | • Quick reference data and Characteristics: I_R : values revised | | | |
| PMEG3001EEF v.4 | 20181114 | Product data sheet | - | PMEG3001EEF v.3 |
| PMEG3001EEF v.3 | 20181012 | Product data sheet | - | PMEG3001EEF v.2 |
| PMEG3001EEF v.2 | 20181002 | Product data sheet | - | PMEG3001EEF v.1 |
| PMEG3001EEF v.1 | 20180716 | Objective data sheet | - | - |

15. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|--------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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- [2] The term 'short data sheet' is explained in section "Definitions".
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